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Datasheet of N0118GA,412 - SCR SENS 600V 800MA SOT54

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Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier with ultra-sensitive gate in a SOT54 (TO-92) plastic package.

2. Features and benefits

- High voltage capability
- Planar passivated for voltage ruggedness and reliability
- Ultra sensitive gate

3. Applications

- Electronic ballasts
- Safety shut down and protection circuits
- Sensing circuits
- Smoke detectors
- Switched Mode Power Supplies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DRM}	repetitive peak off- state voltage			-	-	600	V
V_{RRM}	repetitive peak reverse voltage			-	-	600	V
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 ^{\circ}\text{C}$; $t_p = 10 \text{ms}$; Fig. 4; Fig. 5		-	-	8	A
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 67 °C; <u>Fig. 1</u>		-	-	0.51	А
I _{T(RMS)}	RMS on-state current	half sine wave; $T_{lead} \le 67 \text{ °C}$; Fig. 2; Fig. 3		-	-	8.0	A
Static characteristics							
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 ^{\circ}\text{C};$ Fig. 7		0.5	-	7	μА





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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode		А - - К
2	G	gate	<u> </u>	G sym037
3	К	cathode	3 2 1 TO-92 (SOT54)	·

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
N0118GA	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54

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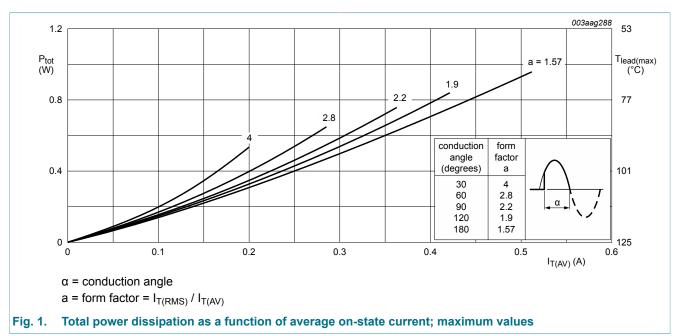
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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	M	lin	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-		600	V
V_{RRM}	repetitive peak reverse voltage		-		600	V
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 67 °C; <u>Fig. 1</u>	-		0.51	Α
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 67 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>	-		8.0	Α
I _{TSM}	non-repetitive peak on-state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; Fig. 4; Fig. 5	-		8	A
		half sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 8.3 \text{ms}$	-		9	A
I ² t	I ² t for fusing	t _p = 10 ms; SIN	-		0.32	A ² s
dl _T /dt	rate of rise of on-state current	I_T = 0.8 A; I_G = 10 mA; dI_G/dt = 0.1 A/ μ s	-		50	A/µs
I _{GM}	peak gate current		-		1	Α
V_{RGM}	peak reverse gate voltage		-		5	V
P _{GM}	peak gate power		-		2	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-		0.1	W
T _{stg}	storage temperature		-4	40	150	°C
Tj	junction temperature		-		125	°C



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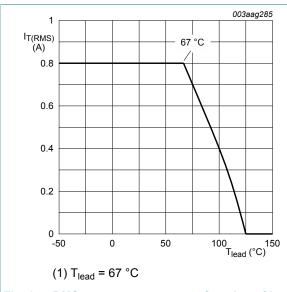
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I_{T(RMS)}

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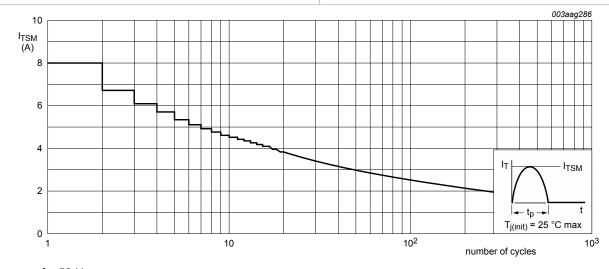


(A) 8 6 4 2 0 L 10-2 10-1 1 10 surge duration (s)

f = 50 Hz; T_{lead} = 67 °C

Fig. 2. RMS on-state current as a function of lead temperature; maximum values

Fig. 3. RMS on-state current as a function of surge duration; maximum values



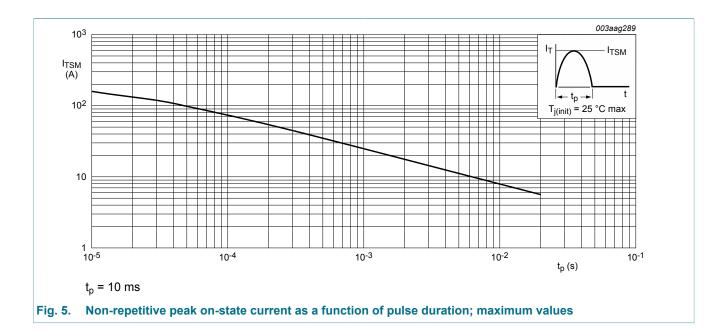
f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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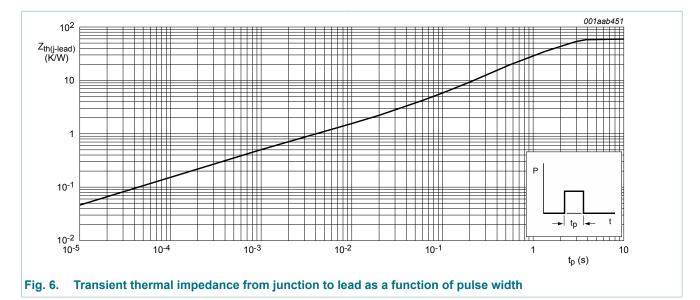
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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-lead)}	thermal resistance from junction to lead	Fig. 6	-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed circuit board mounted: lead length = 4 mm	-	150	-	K/W



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9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					_
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 ^{\circ}\text{C};$ Fig. 7	0.5	-	7	μA
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 8$	-	-	6	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u>	-	-	5	mA
V_{T}	on-state voltage	I _T = 1.6 A; T _j = 25 °C; <u>Fig. 11</u>	-	1.4	1.95	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 12	-	-	0.8	V
I _D	off-state current	V _D = 400 V; T _j = 25 °C	-	-	10	μA
		$V_D = 600 \text{ V}; T_j = 125 \text{ °C}; R_{GK} = 1 \text{ k}\Omega$	-	-	100	μA
I _R	reverse current	$V_R = 600 \text{ V}; T_j = 25 \text{ °C}; R_{GK} = 1 \text{ k}\Omega$	-	-	10	μA
		$V_R = 600 \text{ V}; T_j = 125 \text{ °C}; R_{GK} = 1 \text{ k}\Omega$	-	-	100	μA
Dynamic cl	haracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; R_{GK} = 1 kΩ; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; Fig. 13; Fig. 14	75	-	-	V/µs

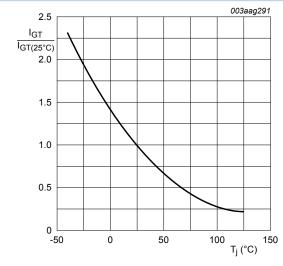


Fig. 7. Normalized gate trigger current as a function of junction temperature

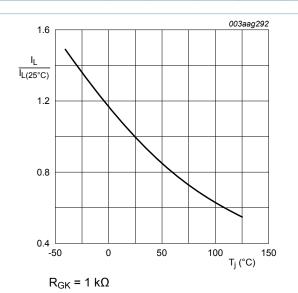


Fig. 8. Normalized latching current as a function of junction temperature

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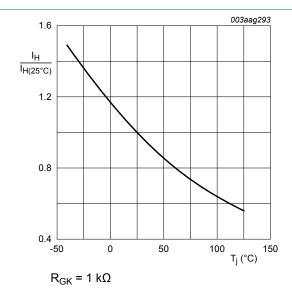
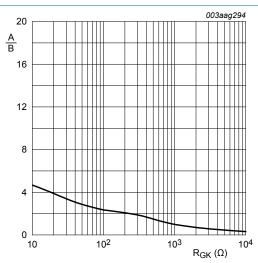


Fig. 9. Normalized holding current as a function of junction temperature

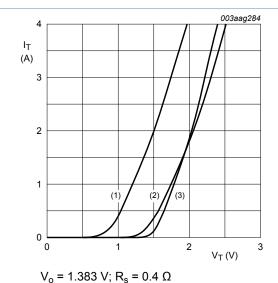


$$A = I_{H} [R_{GK}]$$

$$B = I_{H} [R_{GK} = 1 \text{ k}\Omega]$$

$$T_{i} = 25 \text{ °C}$$

Fig. 10. Normalized holding current as a function of gate-cathode resistance (typical values)



(1) T_i = 125 °C; typical values (2) T_i = 125 °C; maximum values (3) T_j = 25 °C; maximum values

Fig. 11. On-state current as a function of on-state voltage

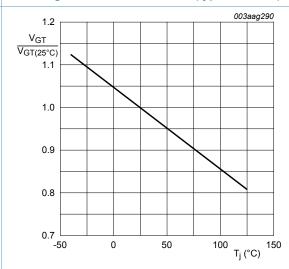


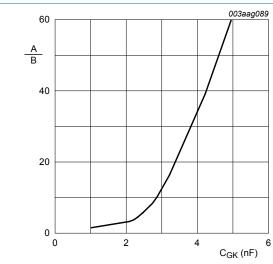
Fig. 12. Normalized gate trigger voltage as a function of junction temperature

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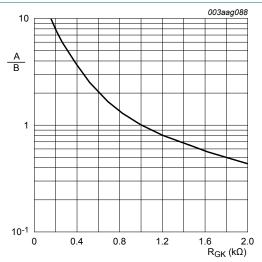
 $A = dV / dt [C_{GK}]$

 $B = dV / dt [R_{GK} = 1 k\Omega]$

 $T_i = 125 \,{}^{\circ}C;$

 R_{GK} = 1 k Ω ; V_{DM} = 402 V

Fig. 13. Normalized dVd/dt immunity as a function of gate-cathode capacitance (typical values)



 $A = dV / dt [C_{GK}]$

 $B = dV / dt [R_{GK} = 1 k\Omega]$

 $T_i = 125 \,{}^{\circ}C;$

 R_{GK} = 1 k Ω ; V_{DM} = 402 V

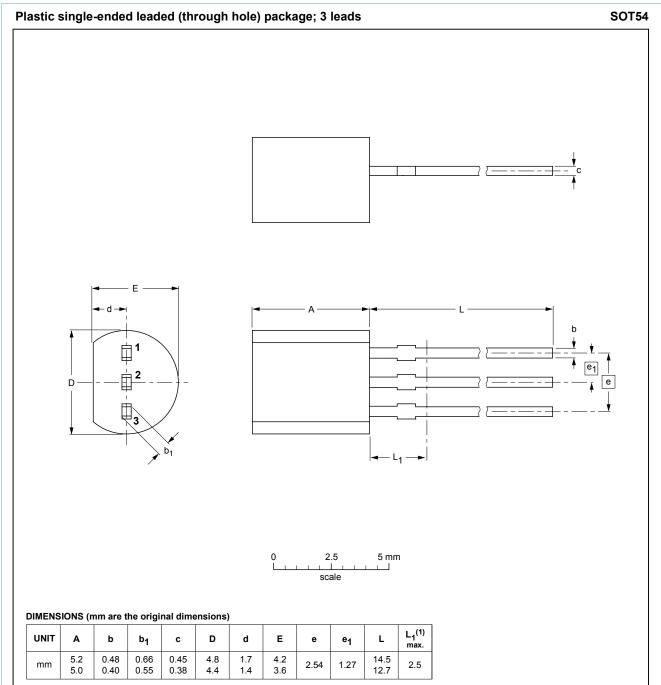
Fig. 14. Normalized dVd/dt immunity as a function of gate-cathode resistance (typical values)



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10. Package outline



1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE			REFER	ENCES	EUROPEAN ISSUE DA	
VERSIC	ON	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT5	4		TO-92	SC-43A		-04-06-28 04-11-16

Fig. 15. Package outline TO-92 (SOT54)

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